



US00D953301S

(12) **United States Design Patent** (10) **Patent No.:** **US D953,301 S**
Ye (45) **Date of Patent:** **** May 31, 2022**

(54) **WIRELESS HEADSET**
(71) Applicant: **Rongqiang Ye**, Guangdong (CN)
(72) Inventor: **Rongqiang Ye**, Guangdong (CN)
(73) Assignee: **Shenzhen Vantide Technology Co. LTD**, Shenzhen (CN)
(**) Term: **15 Years**
(21) Appl. No.: **29/734,197**
(22) Filed: **May 11, 2020**
(51) **LOC (13) Cl.** **14-01**
(52) **U.S. Cl.**
USPC **D14/223**
(58) **Field of Classification Search**
USPC D14/223, 205; D24/174; 128/864, 865,
128/866; 381/380, 381, 322, 328;
455/90.3, 575.1, 569.1
CPC H04R 1/10; H04R 25/00; H04R 25/02;
H04R 1/1066; H04R 1/1016; H04R
5/033; H04R 5/0335; H04R 1/1083;
H04R 1/1041; H04R 1/1075; H04R
1/1058; H04R 1/1091
See application file for complete search history.

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Primary Examiner — Paula Allen Greene
(74) *Attorney, Agent, or Firm* — Justin Lampel

(57) **CLAIM**

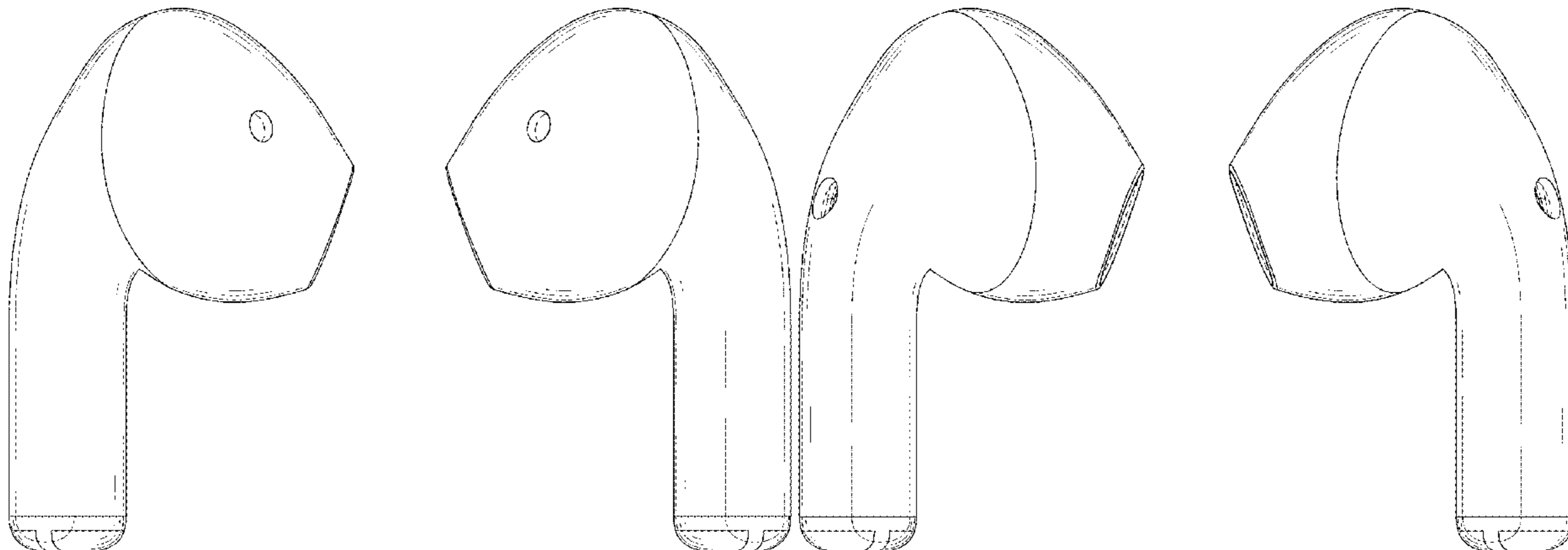
The ornamental design for wireless headset, as shown and described.

DESCRIPTION

FIG. 1 is a front elevational view of a wireless headset showing my new design;
FIG. 2 is a rear elevational view thereof;
FIG. 3 is a top plan view thereof.
FIG. 4 is a bottom plan view thereof;
FIG. 5 is a left side view thereof;
FIG. 6 is a right side view thereof; and,
FIG. 7 is a perspective view thereof.
The broken lines depicted portions of the wireless headset that form no part of the claimed design.

1 Claim, 7 Drawing Sheets

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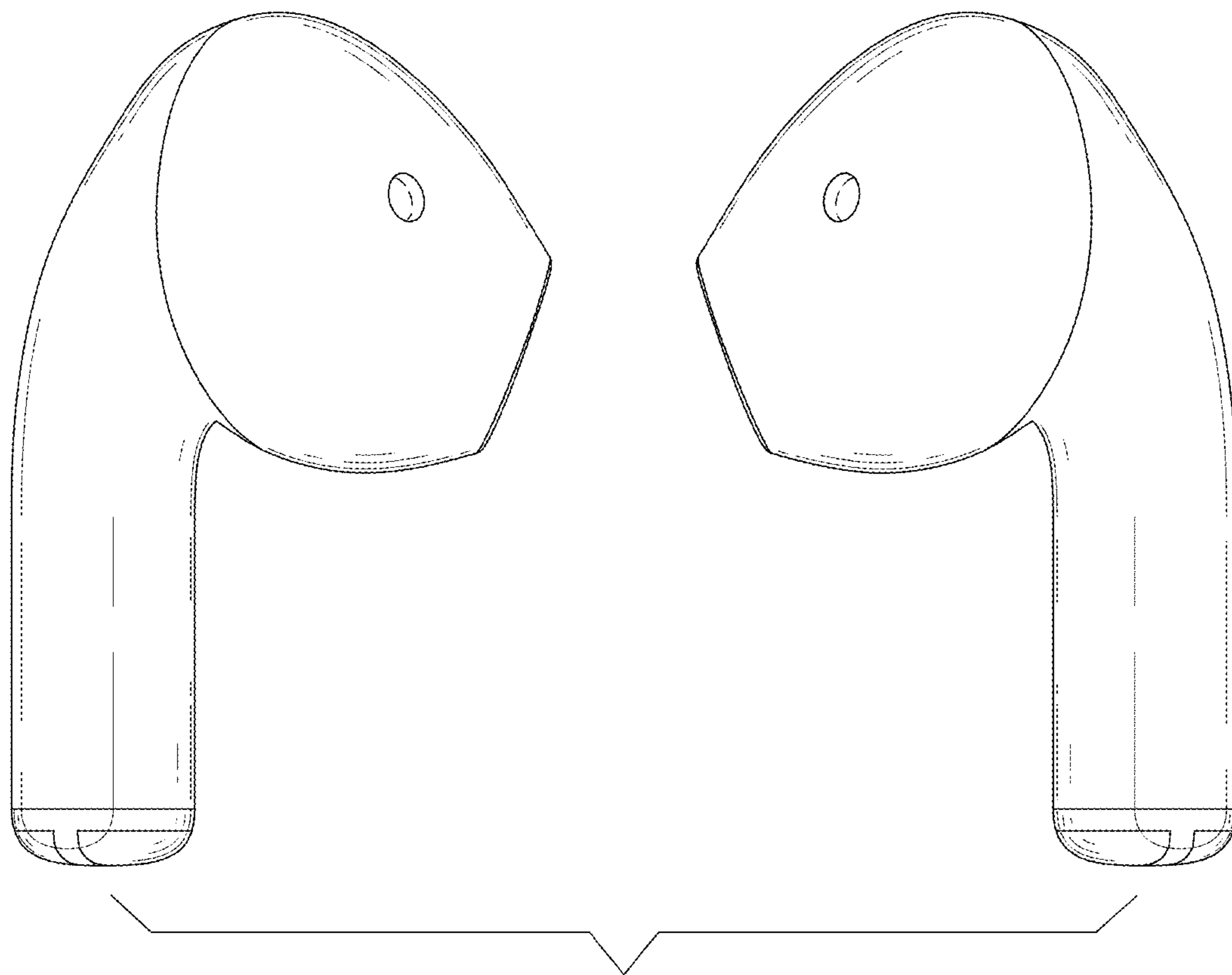


FIG. 1

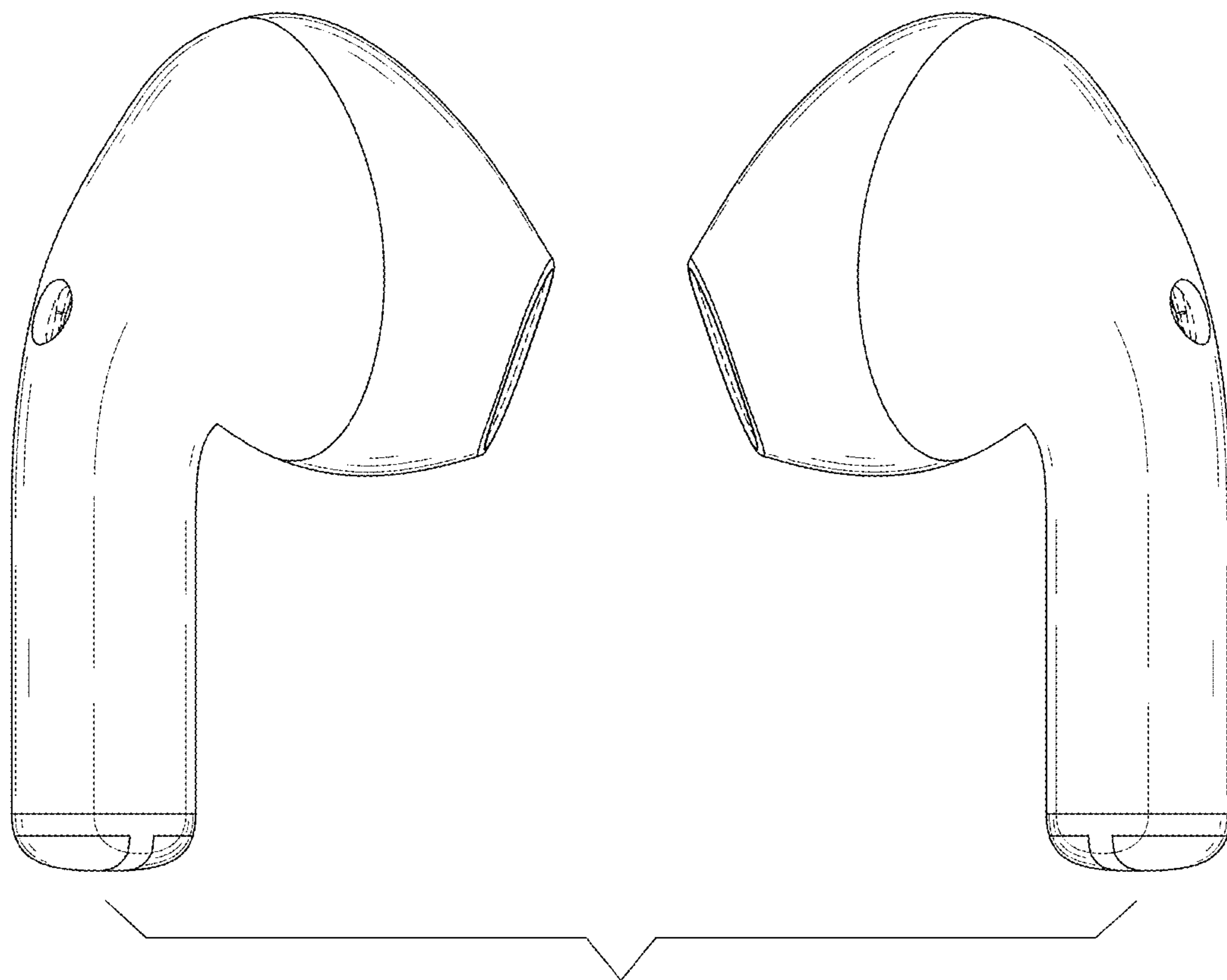


FIG. 2

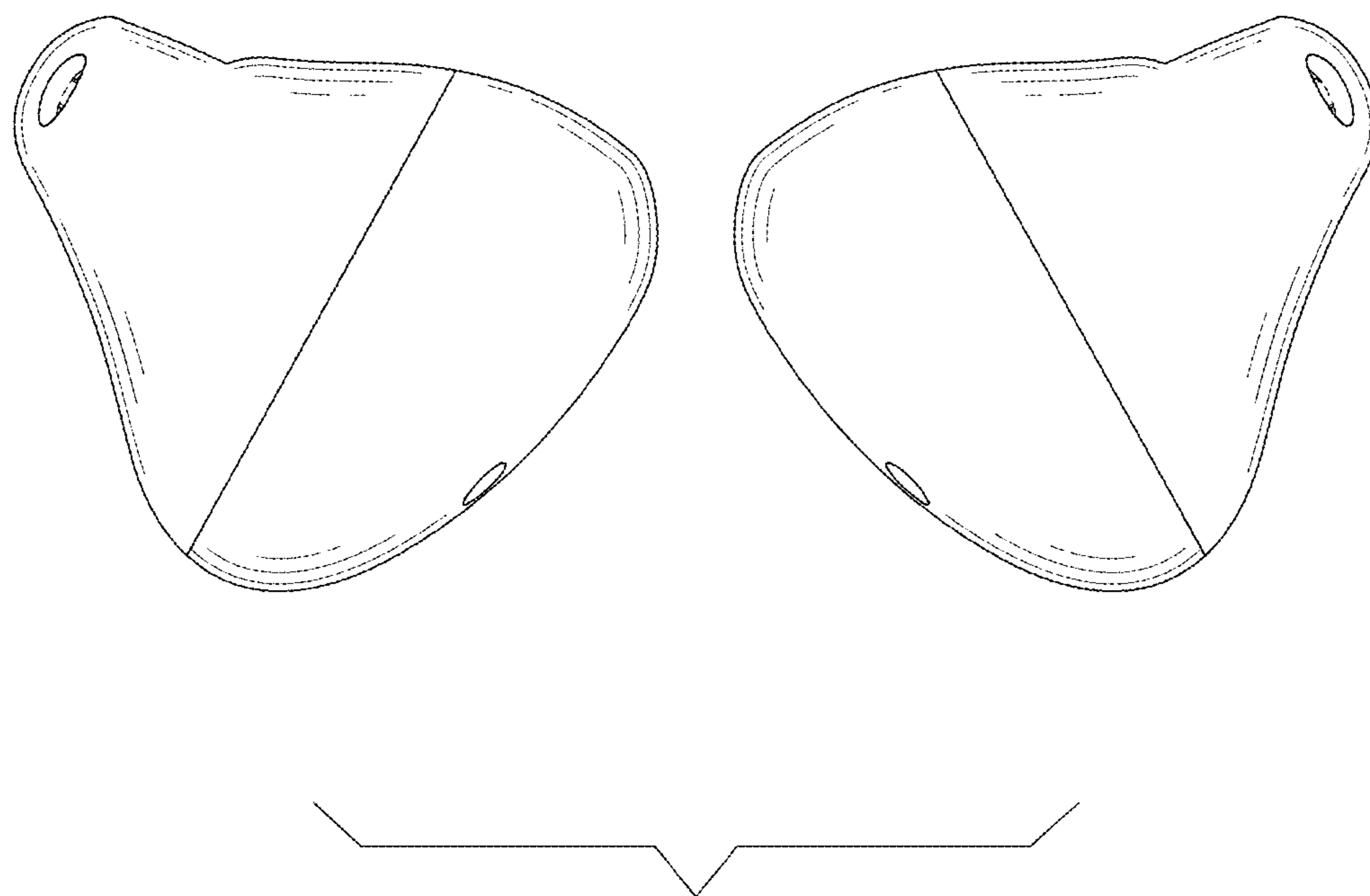


FIG. 3

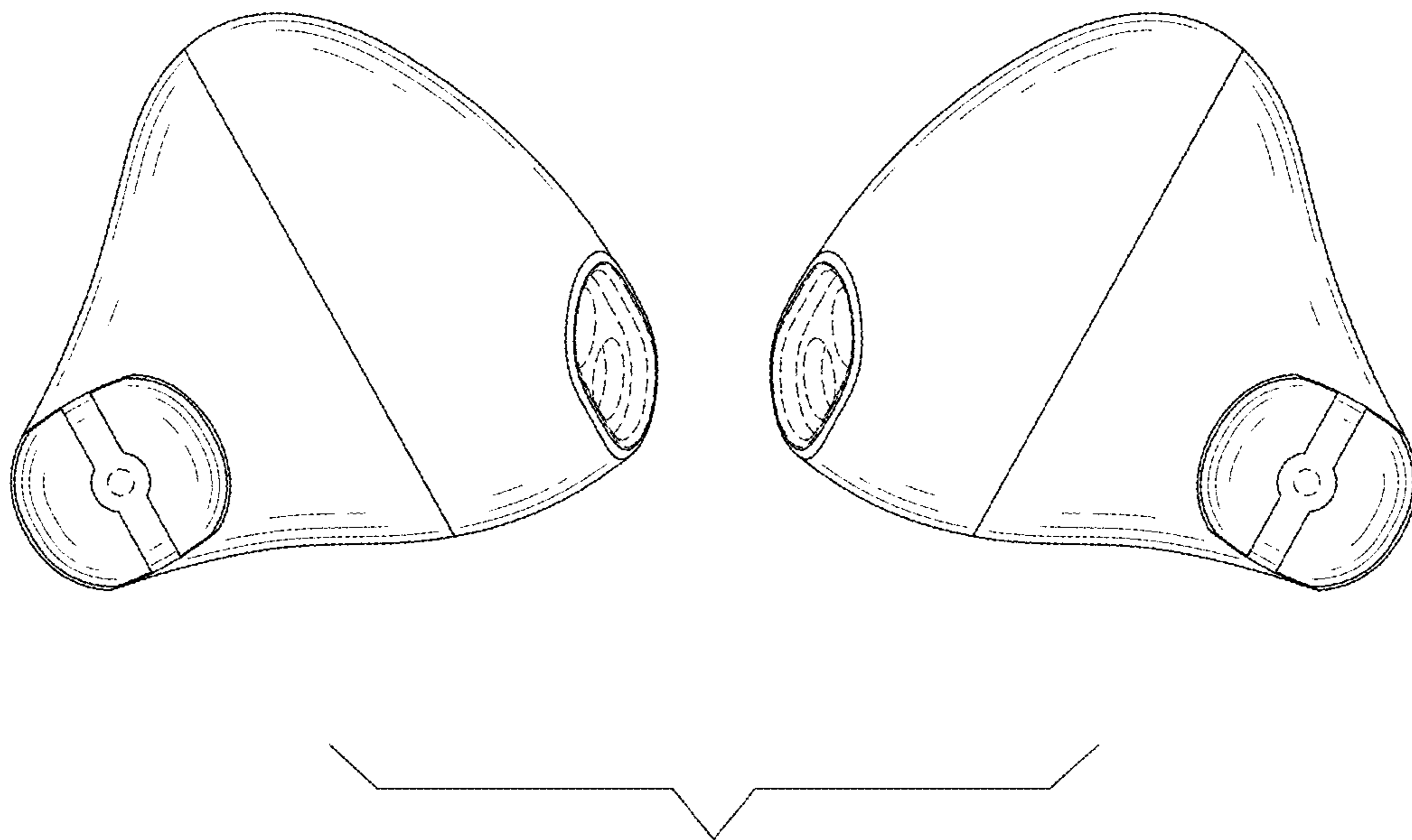


FIG. 4

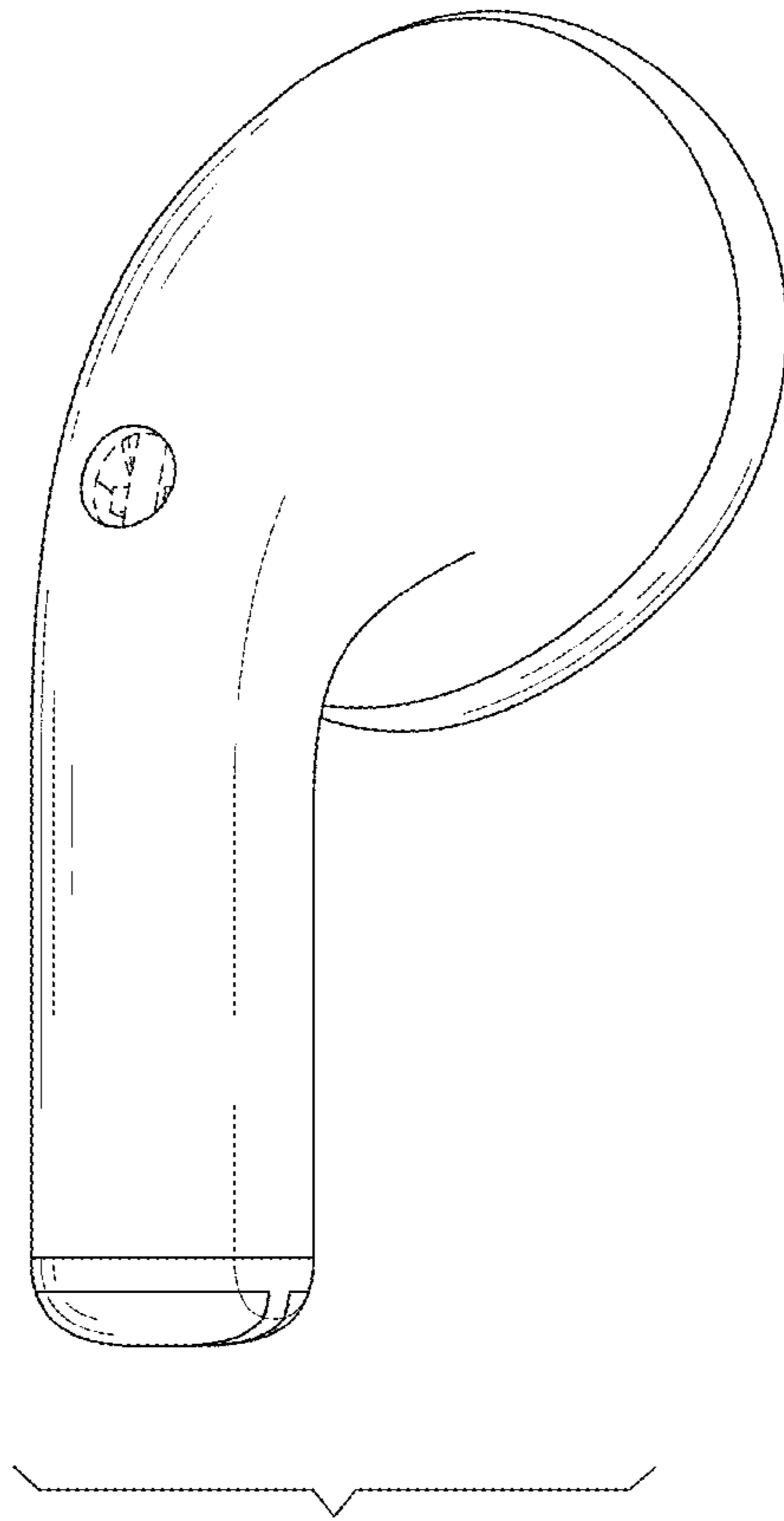


FIG. 5

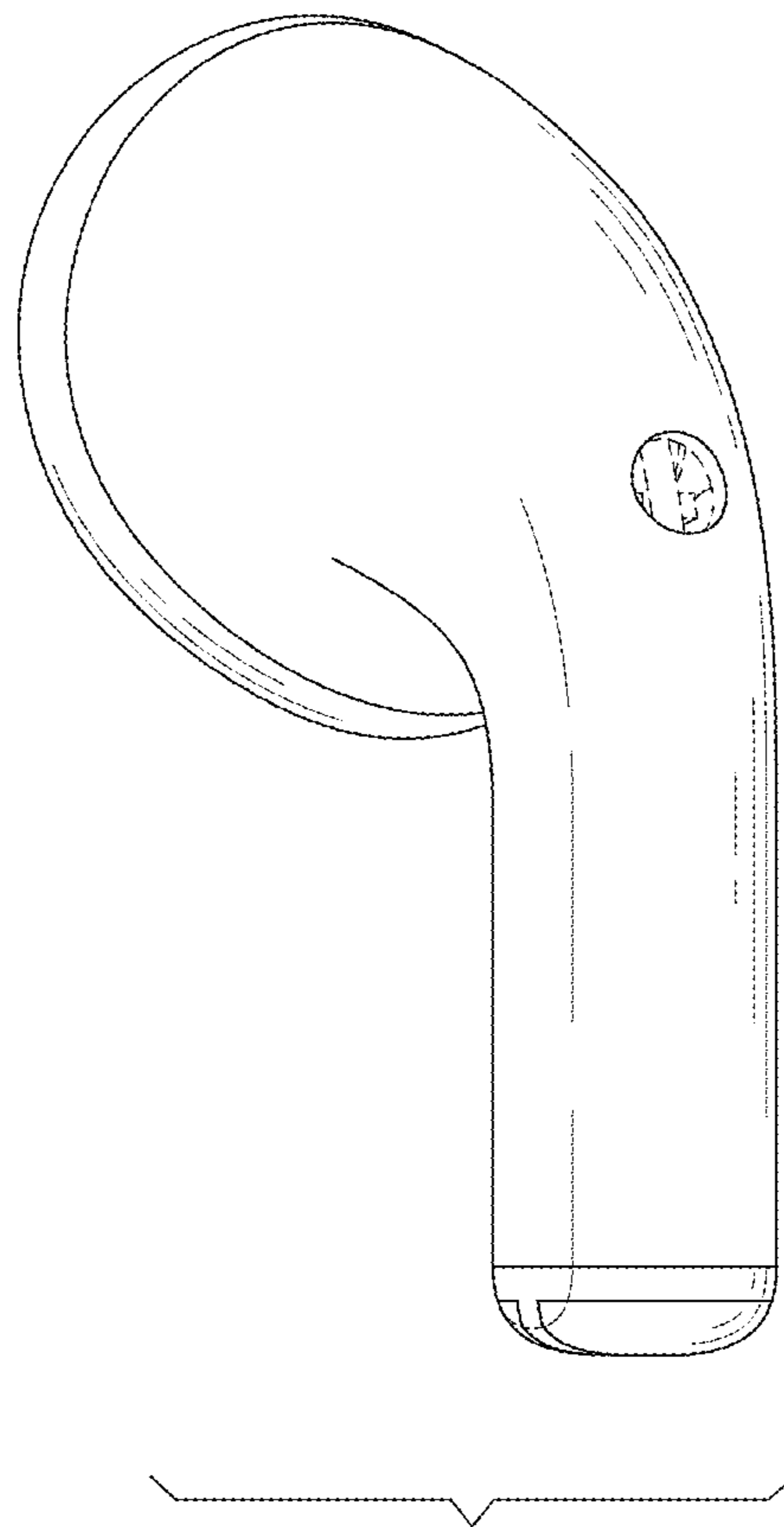


FIG. 6

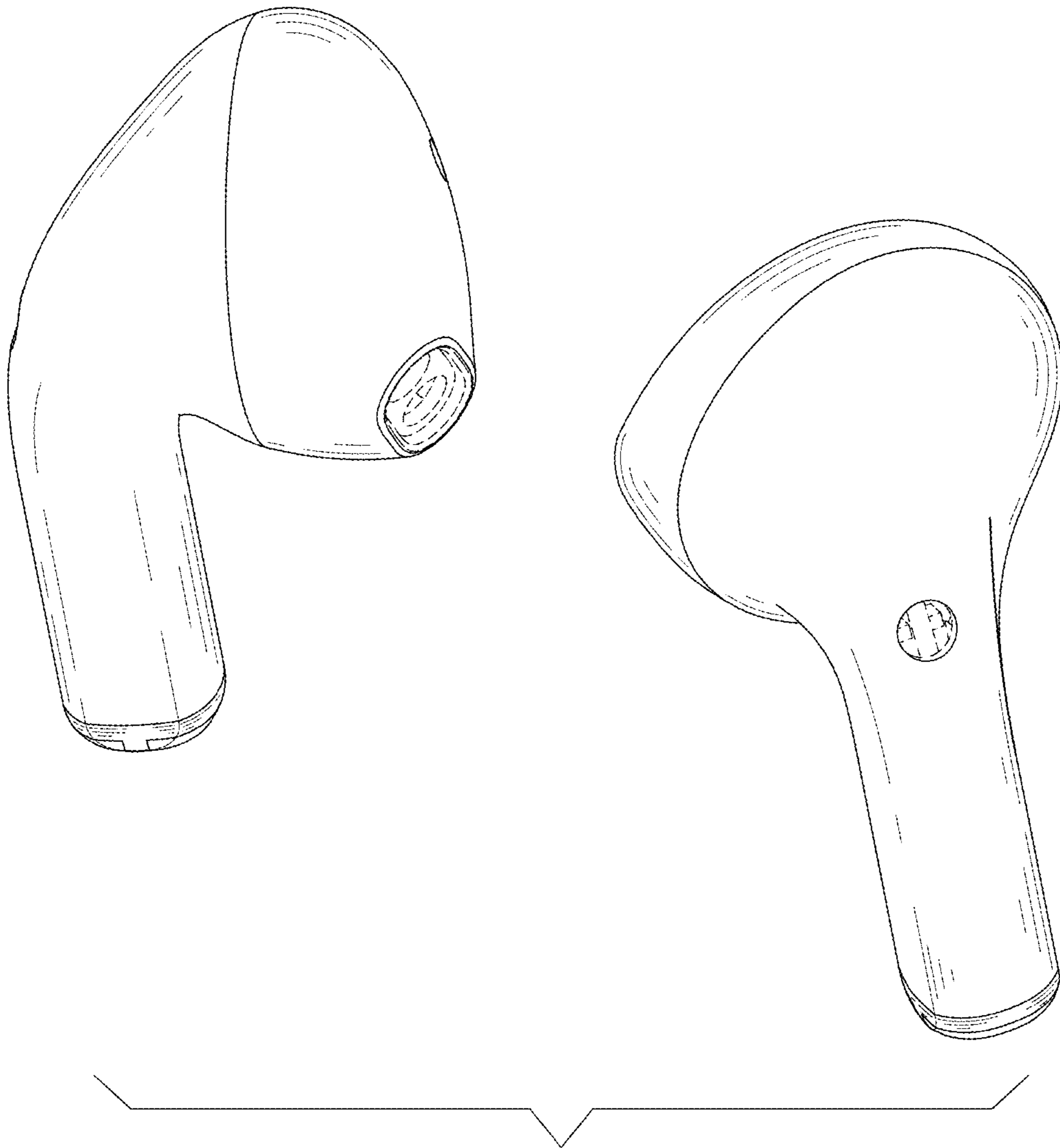


FIG. 7